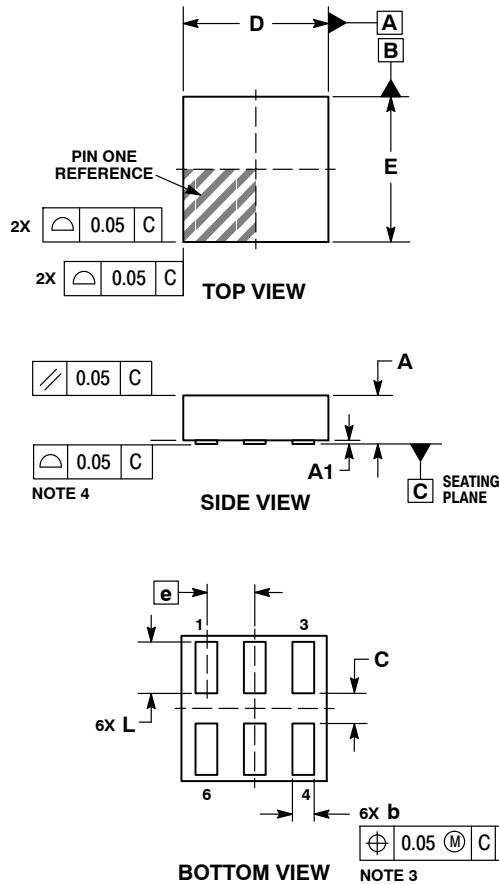




SCALE 4:1

**XDFN6 1.2x1.2, 0.4P**  
CASE 711AA  
ISSUE O

DATE 12 OCT 2010



## NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.25mm FROM TERMINAL TIPS.
4. COPLANARITY APPLIES TO ALL OF THE TERMINALS.

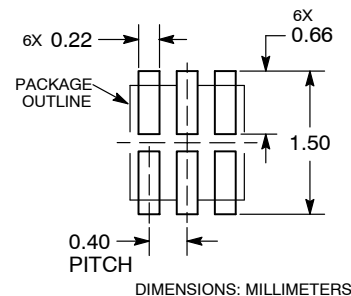
DIM	MILLIMETERS	
	MIN	MAX
A	---	0.40
A1	0.00	0.05
b	0.13	0.23
C	0.20	0.30
D	1.20 BSC	
E	1.20 BSC	
e	0.40 BSC	
L	0.37	0.48

**GENERIC MARKING DIAGRAM\***


XX = Specific Device Code

MM = Date Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

**RECOMMENDED MOUNTING FOOTPRINT\***


\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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<b>DESCRIPTION:</b>	<b>XDFN6, 1.2 X 1.2, 0.4 P</b>	<b>PAGE 1 OF 1</b>

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